



ARF465A(G) ARF465B(G) enotes RoHS Compliant, Pb Free Terminal Finish

Common Source



RF POWER MOSFETS N-CHANNEL ENHANCEMENT MODE

300V

150W

60MHz

The ARF465A and 465B comprise a symmetric pair of common source RF power transistors designed for push-pull scientific, commercial, medical and industrial RF power amplifier applications up to 60 MHz.

• Specified 300 Volt, 40.68 MHz Characteristics:

Output Power = 150 Watts.

Gain = 13dB (Class C)

Efficiency = 75%

- Low Cost Common Source RF Package.
- Low Vth thermal coefficient.
- Low Thermal Resistance.
- Optimized SOA for Superior Ruggedness.

MAXIMUM RATINGS

All Ratings: $T_C = 25^{\circ}C$ unless otherwise specified.

Symbol	Parameter	ARF465A/B(G)	UNIT	
V _{DSS}	Drain-Source Voltage	1200	Volts	
V _{DGO}	Drain-Gate Voltage	1200	Voits	
I _D	Continuous Drain Current @ T _C = 25°C	6	Amps	
V _{GS}	Gate-Source Voltage	±30	Volts	
P _D	Total Power Dissipation @ T _C = 25°C	250	Watts	
R _{eJC}	Junction to Case	0.50	°C/W	
T _J ,T _{STG}	Operating and Storage Junction Temperature Range	-55 to 150	°C	
T _L	Lead Temperature: 0.063" from Case for 10 Sec.	300		

STATIC ELECTRICAL CHARACTERISTICS

Symbol	Characteristic / Test Conditions	MIN	TYP	MAX	UNIT
BV _{DSS}	Drain-Source Breakdown Voltage $(V_{GS} = 0V, I_D = 250 \mu A)$	1200			Volts
V _{DS} (ON)	On State Drain Voltage $^{\textcircled{1}}$ (I _D (ON) = 3A, V _{GS} = 10V)			8	VOILS
	Zero Gate Voltage Drain Current (V _{DS} = V _{DSS} , V _{GS} = 0V)			25	μA
DSS	Zero Gate Voltage Drain Current $(V_{DS} = 0.8 V_{DSS}, V_{GS} = 0V, T_{C} = 125^{\circ}C)$			250	μΛ
I _{GSS}	Gate-Source Leakage Current $(V_{GS} = \pm 30V, V_{DS} = 0V)$			±100	nA
9 _{fs}	Forward Transconductance $(V_{DS} = 25V, I_{D} = 3A)$	3	4		mhos
V _{GS} (TH)	Gate Threshold Voltage $(V_{DS} = V_{GS}, I_{D} = 50 \text{mA})$	3		5	Volts

CAUTION: These Devices are Sensitive to Electrostatic Discharge. Proper Handling Procedures Should Be Followed.

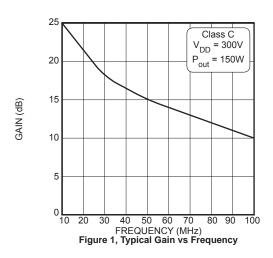
Symbol	Characteristic	Test Conditions	MIN	TYP	MAX	UNIT
C _{iss}	Input Capacitance	V _{GS} = 0V		1200	1500	
C _{oss}	Output Capacitance	V _{DS} = 200V		80	100	pF
C _{rss}	Reverse Transfer Capacitance	f = 1 MHz		30	50	
t _{d(on)}	Turn-on Delay Time	V _{GS} = 15V		7	15	
t _r	Rise Time	V _{DD} = 0.5V		5	10	ns
t _{d(off)}	Turn-off Delay Time	I _D = I _{D[Cont.]} @ 25°C		21	34	
t _f	Fall Time	$R_G = 1.6W$		12	25	

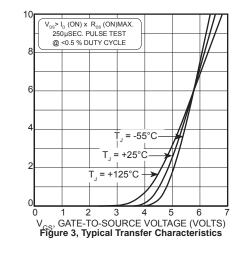
FUNCTIONAL CHARACTERISTICS

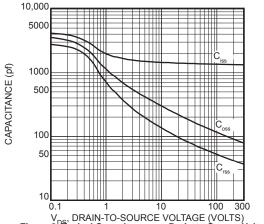
Symbol	Characteristic	Test Conditions	MIN	TYP	MAX	UNIT
G _{PS}	Common Source Amplifier Power Gain	f = 40.68 MHz	13	15		dB
η	Drain Efficiency	$V_{GS} = 0V$ $V_{DD} = 300V$	70	75		%
Ψ	Electrical Ruggedness VSWR 6:1	P _{out} = 150W No Degradation in Outpu		in Output	Power	

 $^{^{\}bigodot}\text{Pulse}$ Test: Pulse width < 380 µS, Duty Cycle < 2%

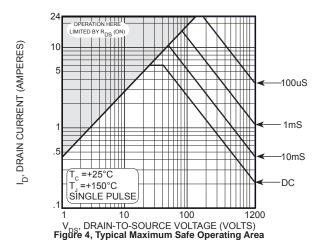
Microsemi Reserves the right to change, without notice, the specifications and information contained herein.



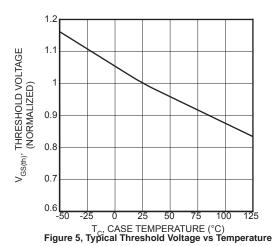


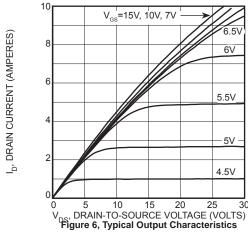


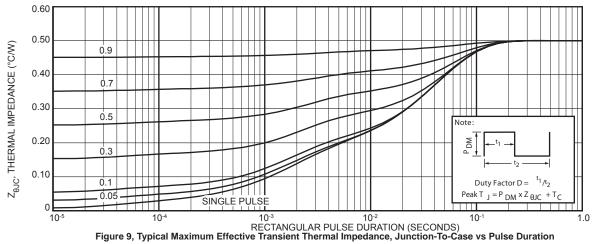
V_D, DRAIN-TO-SOURCE VOLTAGE (VOLTS)
Figure 2, Drain-to-Source Voltage



DRAIN CURRENT (AMPERES)







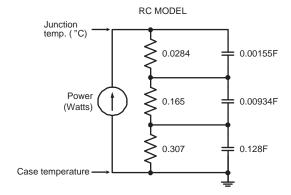


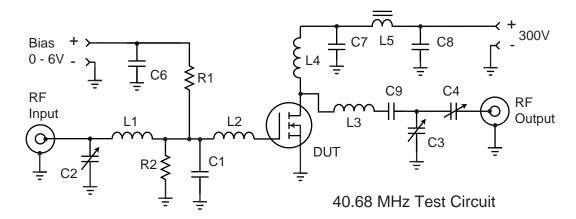
Figure 9a, TRANSIENT THERMAL IMPEDANCE MODEL

Table 1 - Typical Class AB Large Signal input - Output Impedance

Freq. (MHz)	$Z_{in}(\Omega)$	$Z_{OL}(\Omega)$
2.0	21.4 - j 8.7	206 - j 45
13.5	2.6 - j 7.3	68 - j 99
27	.54 - j 2.9	22 - j 64
40	.22 - j .69	10.5 - j 44
65	.31 + j 1.65	4.4 - j 27

I_{DQ} = 100mA

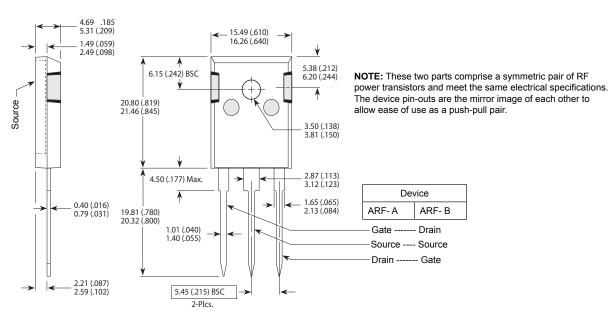
 $\rm Z_{in}$ - Gate shunted with 250 $\rm I_{DQ}$ = $\rm Z_{OL}$ - Conjugate of optimum load for 150 Watts output at V $_{dd}$ = 300V



C1 - 1000pF 100V chip ATC 700B C2-C5 - Arco 463 Mica trimmer C6-C8 - .01 μ F 500V ceramic chip C9 - 2200 pF COG 500 V chip L1 - 4t #20 AWG .25"ID .3"L ~110 nH L2 - 2t #20 AWG .25"ID .3"L ~ 25 nH

L3-- 4t #16 AWG .4" ID .5"L ~290 nH L4 -- 25t #24 AWG .35"ID ~2uH L5-- VK200-4B ferrite choke 3uH R1-R2 -- 51 Ohm 0.5W Carbon DUT = ARF465A/B

TO-247 Package Outline



Dimensions in Millimeters and (Inches)

HAZARDOUS MATERIAL WARNING:

The ceramic portion of the device between leads and mounting flange is beryllium oxide. Beryllium oxide dust is highly toxic when inhaled. Care must be taken during handling and mounting to avoid damage to this area. These devices must never be thrown away with general industrial or domestic waste.

Disclaimer:

The information contained in the document (unless it is publicly available on the Web without access restrictions) is PROPRIETARY AND CONFIDENTIAL information of Microsemi and cannot be copied, published, uploaded, posted, transmitted, distributed or disclosed or used without the express duly signed written consent of Microsemi. If the recipient of this document has entered into a disclosure agreement with Microsemi, then the terms of such Agreement will also apply. This document and the information contained herein may not be modified, by any person other than authorized personnel of Microsemi. No license under any patent, copyright, trade secret or other intellectual property right is granted to or conferred upon you by disclosure or delivery of the information, either expressly, by implication, inducement, estoppels or otherwise. Any license under such intellectual property rights must be approved by Microsemi in writing signed by an officer of Microsemi.

Microsemi reserves the right to change the configuration, functionality and performance of its products at anytime without any notice. This product has been subject to limited testing and should not be used in conjunction with life-support or other mission-critical equipment or applications. Microsemi assumes no liability whatsoever, and Microsemi disclaims any express or implied warranty, relating to sale and/or use of Microsemi products including liability or warranties relating to fitness for a particular purpose, merchantability, or infringement of any patent, copyright or other intellectual property right. Any performance specifications believed to be reliable but are not verified and customer or user must conduct and complete all performance and other testing of this product as well as any user or customers final application. User or customer shall not rely on any data and performance specifications or parameters provided by Microsemi. It is the customer's and user's responsibility to independently determine suitability of any Microsemi product and to test and verify the same. The information contained herein is provided "AS IS, WHERE IS" and with all faults, and the entire risk associated with such information is entirely with the User. Microsemi specifically disclaims any liability of any kind including for consequential, incidental and punitive damages as well as lost profit. The product is subject to other terms and conditions which can be located on the web at http://www.microsemi.com/legal/tnc.asp

X-ON Electronics

Largest Supplier of Electrical and Electronic Components

Click to view similar products for RF MOSFET Transistors category:

Click to view products by Microsemi manufacturer:

Other Similar products are found below:

MRF492 MRFE8VP8600HR5 ARF1511 ARF465BG BF 2030 E6814 BLF861A DU1215S DU28200M UF28100M DU2820S MRF426

ARF468AG ARF468BG MAPHST0045 DU2860U MRFE6VP5300NR1 BF2040E6814HTSA1 LET9060S MRF136Y BF999E6327HTSA1

SD2931-12MR BF998E6327HTSA1 AFT05MS006NT1 MRF141 MRF171 MRF172 MRF174 SD2942 QPD1020SR BF 1005S E6327

MRF134 MRF136 MRF137 MRF141G MRF151A MRF151G MRF157 MRF158 MRF160 MRF166C MRF171A MRF177 UF2840G

TGF3021-SM ARF1510 ARF448BG ARF449AG ARF466BG VRF150 VRF3933